Vishay Siliconix

N-Channel 40 V (D-S) MOSFET



PRODUCT SUMMARY	
V _{DS} (V)	40
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10 \text{ V}$	0.0022
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.0032
Q _g typ. (nC)	21.5
I _D (A) ^a	128
Configuration	Single

FEATURES

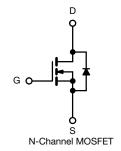
- TrenchFET® Gen IV power MOSFET
- 40 V drain-source break-down voltage
- Tuned for low Qq and Qoss
- 100 % R_a and UIS tested

 Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



APPLICATIONS

- Synchronous rectification
- High power density DC/DC
- Motor drive control



ORDERING INFORMATION	
Package	PowerPAK SO-8
Lead (Pb)-free and halogen-free	SIRA54ADP-T1-RE3

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V_{DS}	40	
Gate-source voltage		V _{GS}	+20, -16	V
	T _C = 25 °C		128	
Continuous drain surrent (T. 150 °C)	T _C = 70 °C		103	
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	36.2 ^{b, c}	
	T _A = 70 °C		29 ^{b, c}	
Pulsed drain current (t = 100 μs)	•	I _{DM}	300	A
Continuous source-drain diode current	T _C = 25 °C		59.7	
Continuous source-drain diode current	T _A = 25 °C	I _S	4.7 b, c	
Single pulse avalanche current	I 0.1 mal I	I _{AS}	25	
Single pulse avalanche Energy	L = 0.1 mH	E _{AS}	31.25	mJ
Maximum power dissipation	T _C = 25 °C		65.7	
	T _C = 70 °C		425	w
	T _A = 25 °C	P _D	5.2 ^{b, c}	
	T _A = 70 °C		3.3 b, c	
Operating junction and storage temperature ra	inge	T _J , T _{stg}	-55 to +150	%0
Soldering recommendations (peak temperature	e) ^{d, e}	3	260	°C

THERMAL RESISTANCE RATING	S				
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient b, f	t ≤ 10 s	R _{thJA}	20	24	°C/W
Maximum junction-to-case (drain)	Steady state	R _{thJC}	1.5	1.9	C/VV

Notes

- a. Based on $T_C = 25 \, ^{\circ}C$
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- f. Maximum under steady state conditions is 62.5 °C/W



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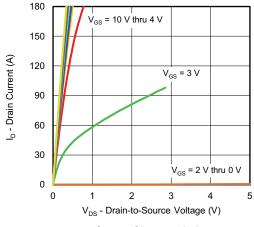
Zero gate voltage drain current IDSS VE Drain-source on-state resistance a RDS(on) RDS(on) Forward transconductance a gfs gfs Dynamic b Input capacitance Ciss Output capacitance Coss VE Reverse transfer capacitance Crss Total gate charge Qg VE Gate-source charge Qgd VE Gate-drain charge Qgd VE Output charge Qoss Coss Gate resistance Rg Turn-on delay time td(on) Rise time tr ID Turn-off delay time tf ID Fall time tf Turn-on delay time td(on) Rise time tr Turn-on delay time tf	TEST CONDITIONS $V_{GS} = 0 \text{ V, } I_D = 1 \text{ mA}$ $I_D = 1 \text{ mA}$ $I_D = 250 \mu\text{A}$ $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$ $V_{DS} = 0 \text{ V, } V_{GS} = +20, -16 \text{ V}$ $V_{DS} = 40 \text{ V, } V_{GS} = 0 \text{ V}$ $S = 40 \text{ V, } V_{GS} = 0 \text{ V, } T_J = 75 \text{ °C}$ $V_{GS} = 10 \text{ V, } I_D = 15 \text{ A}$ $V_{DS} = 4.5 \text{ V, } I_D = 15 \text{ A}$ $V_{DS} = 10 \text{ V, } I_D = 15 \text{ A}$ $V_{DS} = 20 \text{ V, } V_{GS} = 0 \text{ V, } f = 1 \text{ MHz}$ $S = 20 \text{ V, } V_{GS} = 10 \text{ V, } I_D = 10 \text{ A}$ $S = 20 \text{ V, } V_{GS} = 4.5 \text{ V, } I_D = 10 \text{ A}$		- 25 -5.2 0.0018 0.0024 98 3850 655 75 46.7 21.5	- 2.5 ± 100 1 20 0.0022 0.0032 70 32	V mV/°C V nA μA Ω S
Drain-source breakdown voltage V _{DS} V _{DS} temperature coefficient ΔV _{DS} /T _J V _{GS(th)} temperature coefficient ΔV _{GS(th)} /T _J Gate-source threshold voltage V _{GS(th)} Gate-source leakage I _{GSS} Zero gate voltage drain current I _{DSS} Drain-source on-state resistance a R _{DS(on)} Forward transconductance a g _{fs} Dynamic b Input capacitance Input capacitance C _{iss} Output capacitance C _{oss} Reverse transfer capacitance C _{rss} Total gate charge Q _g Gate-source charge Q _{gs} Gate-drain charge Q _{gs} Output charge Q _{oss} Gate resistance R _g Turn-on delay time t _{d(on)} Rise time t _f Turn-on delay time t _{d(on)} Fall time t _f Turn-on delay time t _{d(on)} Rise time t _f	$\begin{split} I_D &= 1 \text{ mA} \\ I_D &= 250 \mu\text{A} \\ V_{DS} &= V_{GS}, I_D = 250 \mu\text{A} \\ V_{DS} &= 0 \text{ V}, V_{GS} = +20, -16 \text{ V} \\ V_{DS} &= 40 \text{ V}, V_{GS} = 0 \text{ V} \\ S &= 40 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 75 \text{ °C} \\ V_{GS} &= 10 \text{ V}, I_D = 15 \text{ A} \\ V_{GS} &= 4.5 \text{ V}, I_D = 15 \text{ A} \\ V_{DS} &= 10 \text{ V}, I_D = 15 \text{ A} \\ \end{split}$	- - 1 - - - - -	25 -5.2 - - - 0.0018 0.0024 98 3850 655 75 46.7 21.5	- 2.5 ± 100 1 20 0.0022 0.0032 - - - - - 70	mV/°C V nA μA Ω
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{split} I_D &= 1 \text{ mA} \\ I_D &= 250 \mu\text{A} \\ V_{DS} &= V_{GS}, I_D = 250 \mu\text{A} \\ V_{DS} &= 0 \text{ V}, V_{GS} = +20, -16 \text{ V} \\ V_{DS} &= 40 \text{ V}, V_{GS} = 0 \text{ V} \\ S &= 40 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 75 \text{ °C} \\ V_{GS} &= 10 \text{ V}, I_D = 15 \text{ A} \\ V_{GS} &= 4.5 \text{ V}, I_D = 15 \text{ A} \\ V_{DS} &= 10 \text{ V}, I_D = 15 \text{ A} \\ \end{split}$	- - 1 - - - - -	25 -5.2 - - - 0.0018 0.0024 98 3850 655 75 46.7 21.5	- 2.5 ± 100 1 20 0.0022 0.0032 - - - - - 70	mV/°C V nA μA Ω
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$I_D = 250 \ \mu A$ $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ $V_{DS} = 0 \ V, V_{GS} = +20, -16 \ V$ $V_{DS} = 40 \ V, V_{GS} = 0 \ V$ $V_{DS} = 40 \ V, V_{GS} = 0 \ V, V_{DS} = 75 \ ^{\circ}C$ $V_{GS} = 10 \ V, I_D = 15 \ A$ $V_{DS} = 4.5 \ V, I_D = 15 \ A$ $V_{DS} = 10 \ V, I_D = 15 \ A$ $V_{DS} = 20 \ V, V_{DS} = 0 \ V, I_D = 10 \ A$	- 1 - - - - -	-5.2 - - - 0.0018 0.0024 98 3850 655 75 46.7 21.5	- 2.5 ±100 1 20 0.0022 0.0032 - - - - - 70	V nA μA Ω S
	$V_{DS} = V_{GS}, I_D = 250 \mu A$ $V_{DS} = 0 \text{ V}, V_{GS} = +20, -16 \text{ V}$ $V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$ $S = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 75 ^{\circ}\text{C}$ $V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$ $V_{DS} = 4.5 \text{ V}, I_D = 15 \text{ A}$ $V_{DS} = 10 \text{ V}, I_D = 15 \text{ A}$ $V_{DS} = 10 \text{ V}, I_D = 15 \text{ A}$ $V_{DS} = 10 \text{ V}, I_D = 15 \text{ A}$ $V_{DS} = 20 \text{ V}, V_{SS} = 0 \text{ V}, V_{SS} = 10 \text{ V}$	1 - - - - -	- - 0.0018 0.0024 98 3850 655 75 46.7 21.5	± 100 1 20 0.0022 0.0032 - - - - - 70	nA μA Ω S
Gate-source leakage I _{GSS} Zero gate voltage drain current I _{DSS} Drain-source on-state resistance a R _{DS(on)} Forward transconductance a gfs Dynamic b Input capacitance Output capacitance C _{iss} Output capacitance C _{rss} Reverse transfer capacitance C _{rss} Total gate charge Qg Gate-source charge Qgs Output charge Qoss Gate-drain charge Qoss Gate resistance Rg Turn-on delay time t _{d(on)} Rise time t _r Turn-off delay time t _{d(off)} Fall time t _f Turn-on delay time t _{d(on)} Rise time t _r	$V_{DS} = 0 \text{ V}, V_{GS} = +20, -16 \text{ V}$ $V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$ $S = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 75 \text{ °C}$ $V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$ $V_{GS} = 4.5 \text{ V}, I_D = 15 \text{ A}$ $V_{DS} = 10 \text{ V}, I_D = 15 \text{ A}$ $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, I_D = 10 \text{ A}$ $V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	- - - - - -	- 0.0018 0.0024 98 3850 655 75 46.7 21.5	± 100 1 20 0.0022 0.0032 - - - - - 70	nA μA Ω S
Zero gate voltage drain current IDSS VEX. Drain-source on-state resistance a RDS(on) RDS(on) Forward transconductance a gfs Gfs Dynamic b VI VI Input capacitance Coss VI Output capacitance Crss VI Reverse transfer capacitance Crss VI Total gate charge Qg VI Gate-source charge Qgs VI Gate-drain charge Qgd Output charge Gate resistance Rg Turn-on delay time td(on) Rise time tr ID Turn-off delay time tf ID Fall time tf ID Turn-on delay time td(on) ID Rise time tr ID	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$ $S = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 75 \text{ °C}$ $V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$ $V_{GS} = 4.5 \text{ V}, I_D = 15 \text{ A}$ $V_{DS} = 10 \text{ V}, I_D = 15 \text{ A}$ $V_{DS} = 20 \text{ V}, V_{DS} = 10 \text{ V}, I_D = 10 \text{ A}$ $V_{DS} = 20 \text{ V}, V_{DS} = 10 \text{ V}, I_D = 10 \text{ A}$	- - - - -	- 0.0018 0.0024 98 3850 655 75 46.7 21.5	1 20 0.0022 0.0032 - - - - - 70	μA Ω S
Drain-source on-state resistance a R _{DS(on)}	$_{S} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 75 \text{ °C}$ $V_{GS} = 10 \text{ V}, I_{D} = 15 \text{ A}$ $V_{GS} = 4.5 \text{ V}, I_{D} = 15 \text{ A}$ $V_{DS} = 10 \text{ V}, I_{D} = 15 \text{ A}$ $V_{DS} = 20 \text{ V}, V_{GS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, V_{DS} = 10 \text{ A}$		0.0024 98 3850 655 75 46.7 21.5	20 0.0022 0.0032 - - - - - 70	Ω S
Drain-source on-state resistance a R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$ $V_{GS} = 4.5 \text{ V}, I_D = 15 \text{ A}$ $V_{DS} = 10 \text{ V}, I_D = 15 \text{ A}$ $V_{DS} = 20 \text{ V}, V_{GS} = 20 \text{ V}, I_D = 10 \text{ A}$ $V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$		0.0024 98 3850 655 75 46.7 21.5	0.0022 0.0032 - - - - - 70	S
Forward transconductance a gfs Dynamic b Input capacitance Output capacitance Coss Reverse transfer capacitance Crss Total gate charge Qg Gate-source charge Qgd Output charge Qoss Gate resistance Rg Turn-on delay time td(on) Rise time tf Turn-onf delay time td(off) Fall time tf Turn-on delay time td(on) Rise time tf Rise time tf	$V_{GS} = 4.5 \text{ V}, I_D = 15 \text{ A}$ $V_{DS} = 10 \text{ V}, I_D = 15 \text{ A}$ $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, I_D = 10 \text{ A}$ $V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	- - - - -	0.0024 98 3850 655 75 46.7 21.5	- - - - 70	S
Forward transconductance a gfs Dynamic b Input capacitance Output capacitance Coss Reverse transfer capacitance Crss Total gate charge Qg Gate-source charge Qgd Output charge Qoss Gate resistance Rg Turn-on delay time td(on) Rise time tf Turn-onf delay time td(off) Fall time tf Turn-on delay time td(on) Rise time tf Rise time tf	$V_{DS} = 10 \text{ V}, I_D = 15 \text{ A}$ $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ $V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	- - - -	98 3850 655 75 46.7 21.5	- - - - 70	S
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	_{IS} = 20 V, V _{GS} = 0 V, f = 1 MHz _{IS} = 20 V, V _{GS} = 10 V, I _D = 10 A		3850 655 75 46.7 21.5	- - - 70	-
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	_S = 20 V, V _{GS} = 10 V, I _D = 10 A	-	655 75 46.7 21.5	- - 70	pF
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	_S = 20 V, V _{GS} = 10 V, I _D = 10 A	-	655 75 46.7 21.5	- - 70	pF
	_S = 20 V, V _{GS} = 10 V, I _D = 10 A	-	75 46.7 21.5		pF
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			46.7 21.5		
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$			21.5		
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	_S = 20 V, V _{GS} = 4.5 V, I _D = 10 A	-		32	
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	$_{S} = 20 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	1		
$ \begin{array}{c cccc} Output \ charge & Q_{oss} \\ \hline Gate \ resistance & R_g \\ \hline Turn-on \ delay \ time & t_{d(on)} \\ \hline Rise \ time & t_r \\ \hline Turn-off \ delay \ time & t_{d(off)} \\ \hline Fall \ time & t_f \\ \hline Turn-on \ delay \ time & t_{d(on)} \\ \hline Rise \ time & t_r \\ \hline \end{array} $			9.3	-	nC
$ \begin{array}{c cccc} Gate \ resistance & R_g \\ \hline Turn-on \ delay \ time & t_{d(on)} \\ \hline Rise \ time & t_r \\ \hline Turn-off \ delay \ time & t_{d(off)} \\ \hline Fall \ time & t_f \\ \hline Turn-on \ delay \ time & t_{d(on)} \\ \hline Rise \ time & t_r \\ \hline \end{array} $		-	4	-	
$ \begin{array}{c cccc} Turn\text{-on delay time} & & t_{d(on)} \\ Rise time & & t_r \\ \hline Turn\text{-off delay time} & & t_{d(off)} \\ Fall time & & t_f \\ \hline Turn\text{-on delay time} & & t_{d(on)} \\ Rise time & & t_r \\ \hline \end{array} $	V _{DS} = 20 V, V _{GS} = 0 V	-	24.5	-	
$ \begin{array}{c cccc} \text{Turn-on delay time} & & & & & & & \\ \text{Rise time} & & & & & & \\ \text{Turn-off delay time} & & & & & & \\ \text{Fall time} & & & & & & \\ \text{Turn-on delay time} & & & & & \\ \text{Rise time} & & & & & & \\ \end{array} $	f = 1 MHz	0.5	1.1	1.8	Ω
$ \begin{array}{c cccc} Turn\text{-off delay time} & & t_{d(off)} & \\ \hline Fall time & & t_f & \\ \hline Turn\text{-on delay time} & & t_{d(on)} & \\ \hline Rise time & & t_r & \\ \hline \end{array} $		-	15	30	
$ \begin{array}{ccc} \text{Turn-off delay time} & & t_{\text{d(off)}} & \\ \text{Fall time} & & t_{\text{f}} & \\ \text{Turn-on delay time} & & t_{\text{d(on)}} & \\ \text{Rise time} & & t_{\text{r}} & \\ \end{array} $	$V_{DD} = 20 \text{ V}, R_1 = 2 \Omega$	-	6	12	
	\cong 10 A, V _{GEN} = 10 V, R _g = 1 Ω	-	30	60	
Rise time t _r		-	6	12	
Rise time t _r		-	26	52	ns
	$V_{DD} = 20 \text{ V}, \text{ R}_L = 2 \Omega$ $I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, \text{ R}_g = 1 \Omega$	_	63	126	- - -
Turn-off delay time t _{d(off)} I _D		_	33	66	
Fall time t _f		_	10	20	
Drain-Source Body Diode Characteristics					
Continuous source-drain diode current Is	T _C = 25 °C	_	_	59.7	
Pulse diode forward current ($t_p = 100 \mu s$) I_{SM}	3	-	-	300	Α
Body diode voltage V _{SD}	I _S = 5 A	_	0.72	1.1	V
Body diode reverse recovery time t _{rr}	-3	_	29	58	ns
Body diode reverse recovery charge Q _{rr}		_	23	46	nC
Reverse recovery fall time t _a	I 10 A di/dt _ 100 A/va			-	5
Reverse recovery rise time t _b	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$ $T_{.1} = 25 ^{\circ}\text{C}$	_	15		

Notes

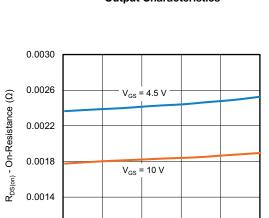
- g. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- h. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.









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I_D - Drain Current (A)

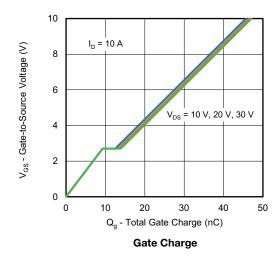
On-Resistance vs. Drain Current

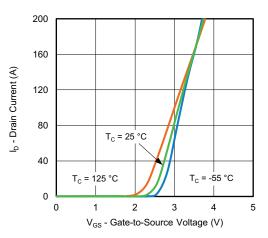
60

80

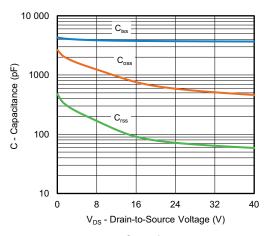
100

40

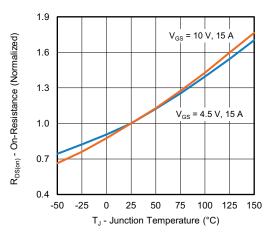




Transfer Characteristics



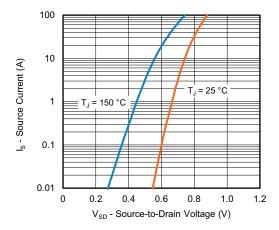
Capacitance



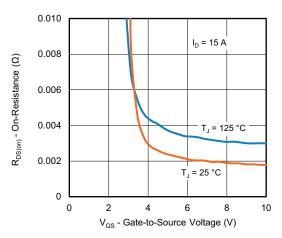
On-Resistance vs. Junction Temperature

0.0010

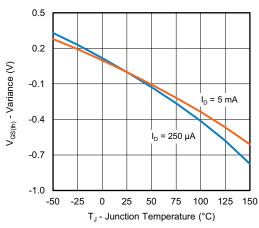




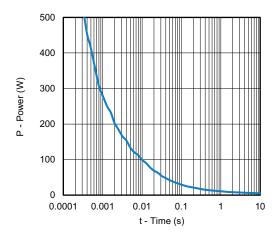
Source-Drain Diode Forward Voltage



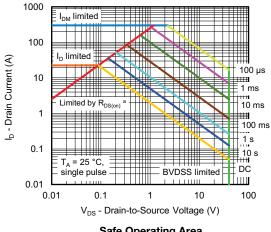
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient

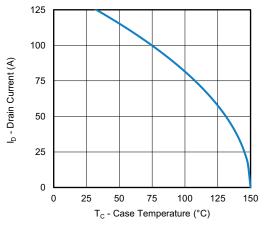


Safe Operating Area

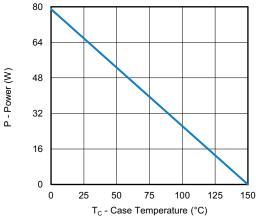
Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

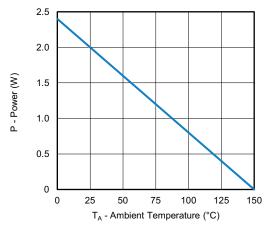




Current Derating a





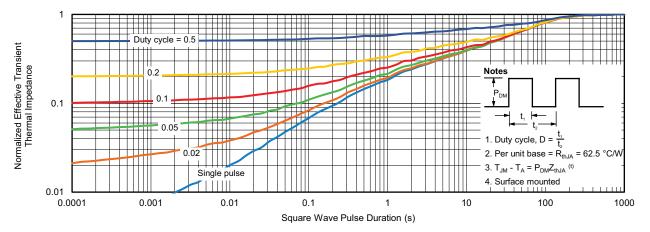


Power, Junction-to-Ambient

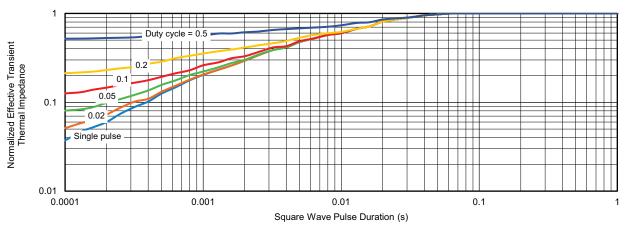
Note

b. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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